ON Semiconductor®



FCA76N60N N-Channel SupreMOS[®] MOSFET

600 V, 76 A, 36 m Ω

Features

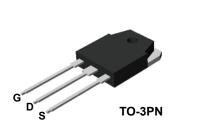
- $R_{DS(on)}$ = 28 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 38 A
- Ultra Low Gate Charge (Typ. Q_g = 218 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 914 pF)
- 100% Avalanche Tested
- RoHS Compliant

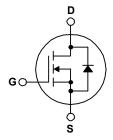
Application

- Solar Inverter
- AC-DC Power Supply

Description

The SupreMOS[®] MOSFET is ON Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCA76N60N	Unit			
V _{DSS}	Drain to Source Voltage	600	V			
V _{GSS}	Gate to Source Voltage			±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		76	•	
		- Continuous (T _C = 100 ^o C)		48.1	— A	
I _{DM}	Drain Current	- Pulsed (Note 1)	228	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			8022	mJ	
I _{AR}	Avalanche Current (N			76	А	
E _{AR}	Repetitive Avalanche Ene	rgy (Note 1)	5.40	mJ	
dv/dt	MOSFET dv/dt Ruggedness (Note 3)			100	V/ns	
	Peak Diode Recovery dv/dt			12		
P _D	Deven Dississeties	$(T_{\rm C} = 25^{\rm o}{\rm C})$		543	W	
	Power Dissipation	- Derate Above 25°C		5.40	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

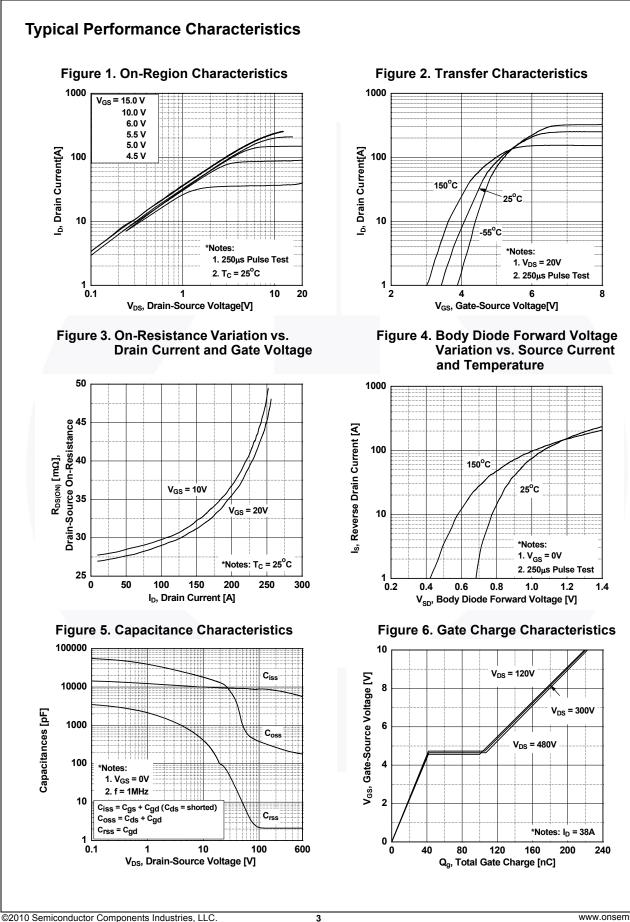
Thermal Characteristics

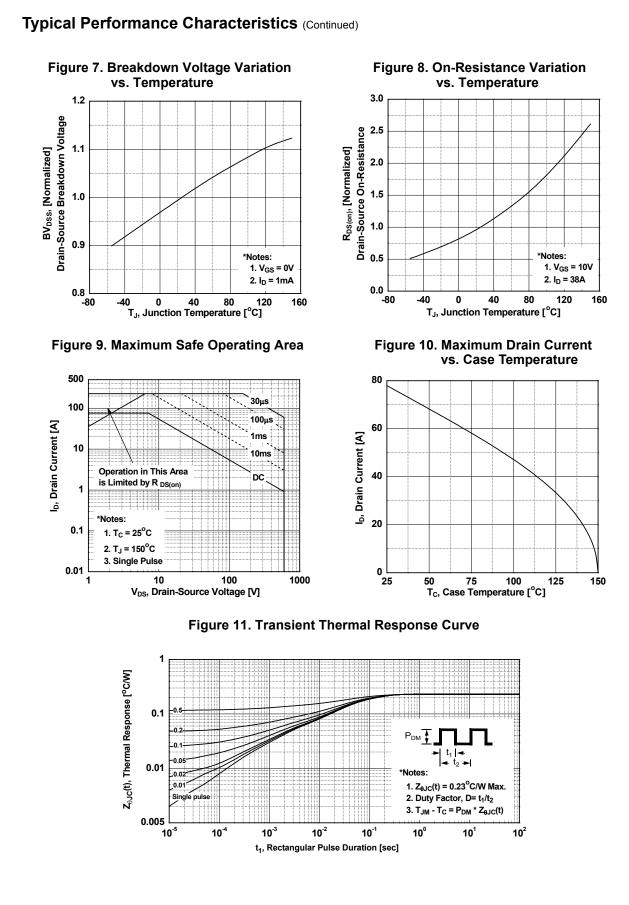
Symbol	Parameter	FCA76N60N	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	0.23	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	0/11

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FCA76N Electrica Symbol		Top Mark	Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity
	160N	FCA76N60N	TO-3PN	Tube	N/A		N/A	30 L	inits
	l Chara	acteristics T _c =	25°C unless	otherwise noted					
		Parameter		Test Conditio	ons	Min.	Тур.	Max.	Uni
Off Charac	teristics								
BV _{DSS}	Drain to Source Breakdown Voltage		tage	I _D = 1 mA, V _{GS} = 0 V,T _J = 25 ^o C		600	-	-	V
ABV _{DSS}		Breakdown Voltage Temperature							
$/\Delta T_J$	Coefficie	0		$I_D = 1 \text{ mA}$, Referenced to $25^{\circ}C$		-	0.73	-	V/°C
	Zoro Col	Zero Gate Voltage Drain Current		V _{DS} = 480 V, V _{GS} = 0 V		-	-	10	^
DSS	Zelo Gal			V_{DS} = 480 V, T _J = 125°	C	-	-	100	μA
GSS	Gate to Body Leakage Current			V_{GS} = ±30 V, V_{DS} = 0 V		-	-	±100	nA
On Charac	teristics	i							
V _{GS(th)}	Gate Thr	Gate Threshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA		2.0	-	4.0	V
R _{DS(on)}	Static Dr	ain to Source On Resis		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 38 \text{ A}$		-	28.5	36.0	mΩ
9 _{FS}	Forward Transconductance			$V_{\rm DS}$ = 20 V, I _D = 38 A		-	88	-	S
Dynamic C	haracte	ristics							
C _{iss}	Input Ca	pacitance				-	9310	12385	pF
C _{oss}		apacitance		V _{DS} = 100 V, V _{GS} = 0 V	',	-	370	495	pF
C _{rss}		Transfer Capacitance		f = 1 MHz		-	3.1	5.0	pF
C _{OSS}		apacitance		V _{DS} = 380 V, V _{GS} = 0 V	/, f = 1 MHz	-	196	-	pF
Coss(eff.)	Effective	Output Capacitance		$V_{DS} = 0 V \text{ to } 380 V, V_{GS}$		-	914	-	pF
$Q_{g(tot)}$		te Charge at 10V			5	-	218	285	nC
Q _{gs}		Source Gate Charge		V _{DS} = 380 V, I _D = 38 A,	-	-	39	-	nC
Q _{gd}		Drain "Miller" Charge		V _{GS} = 10 V	(Nata 4)	-	66	-	nC
ESR		nt Series Resistance (0	G-S)	f = 1 MHz	(Note 4)	-	1.0	-	Ω
Switching	Charact	oristics		L					I
•		Delay Time				-	34	78	ns
t _{d(on)} t _r		Rise Time		V _{DD} = 380 V, I _D = 38 A,	-	_	24	58	ns
t _{d(off)}		Delay Time		$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)		-	235	480	ns
d(off)		Fall Time				-	32	74	ns
			I		(1010-1)				
		e Characteristics		Forward Current				76	A
S		n Pulsed Drain to Source				-	-	228	A
sм √ _{SD}		Source Diode Forward		$V_{GS} = 0 V, I_{SD} = 38 A$		-	-	1.2	A V
		Recovery Time		$V_{GS} = 0 V, I_{SD} = 38 A,$ $V_{GS} = 0 V, I_{SD} = 38 A,$		-	613	-	ns
t _{rr}		Recovery Charge		$v_{GS} = 0 v$, $r_{SD} = 30 A$, $dI_{F}/dt = 100 A/\mu s$	_	_	16	_	μC



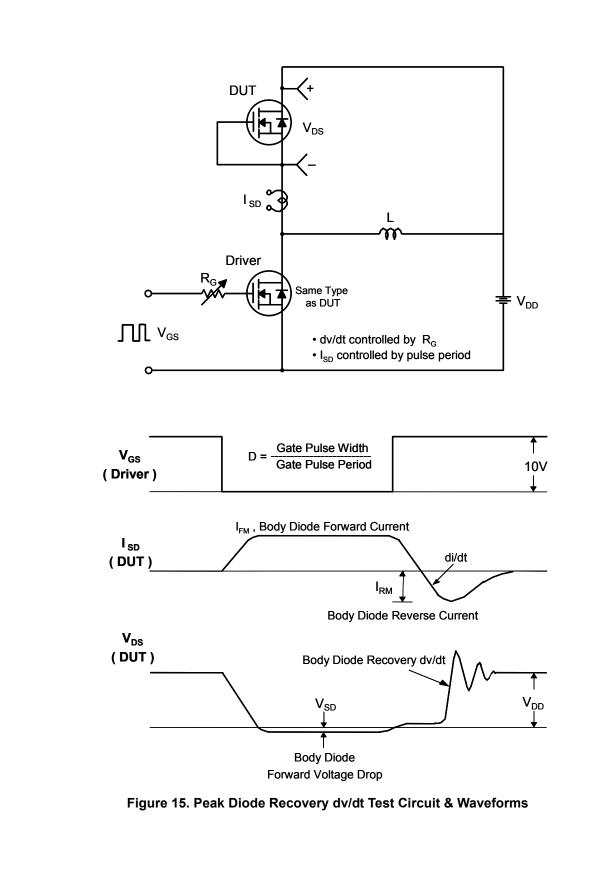


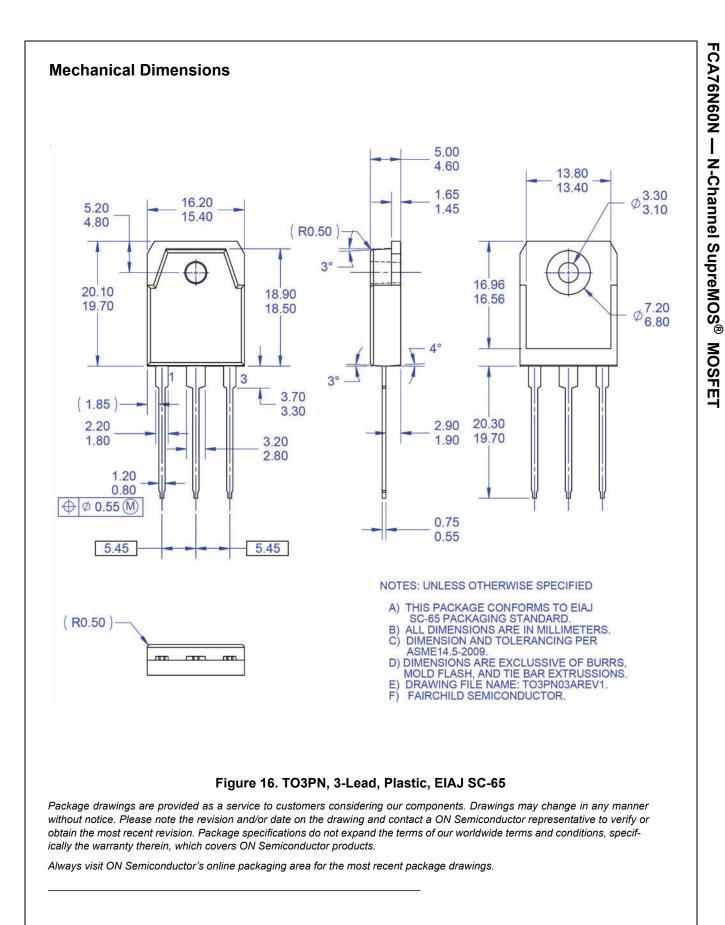
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V_{GS} Ş R Qg F V_{DS} Qgs Q_{gd} • DUT I_G = const. Charge Figure 12. Gate Charge Test Circuit & Waveform R VDS VDS 90% V_{DD} V_{GŞ} R_{G} 10% V_{GS} V_{GS} ∏ DUT 0 С Figure 13. Resistive Switching Test Circuit & Waveforms L $E_{AS} = \frac{1}{2} L I_{AS}^2$ VDS BV_{DSS} ID AS R_G **₽** V_{DD} $I_D(t)$ V_{GS} $V_{DS}(t)$ V_{DD} DUT Time tp Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

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